



- NOTES:
1. MATERIAL
 - 1) HOUSING : HIGH TEMP THERMOPLASTIC UL94V-0 (COLOR:BLACK)
 - 2) TERMINAL : COPPER ALLOY
 - 3) HOLD DOWN : COPPER ALLOY
 2. FINISH
 - 1) TERMINAL : Au PLATING (CONTACT POINT) OVER 50u" NICKEL
 - 2) SOLDER TAIL : 50u" min MATT TIN OVER 50u" NICKEL
 3. THE HOUSING WILL WITHSTAND EXPOSURE TO 260C FOR 10 SEC.
 - IN A WAVE SOLDER APPLICATION WITH A 1.6MM PCB
 4. PRODUCT SPEC: GS-12-494
 - PACKING SPEC: GS-14-1283
 5. PRODUCT NUMBERING
 - 10080211 - X 0 0 X LF

0: 5u" Au PLATING
 1: G/F Au PLATING
 2: 15u" Au PLATING
 3: 30u" Au PLATING

LEAD FREE

1: TRAY PACKING

mot'l. code	tolerances unless otherwise specified	CUSTOMER COPY	title	code
l/r	.X ± 0.38	projection	MICRO S-ATA RECEP	TWN
A	.XX ± 0.25	scale	R/A, DIP TYPE	sheet
B	.XXX ± 0.15	MM	product family SAT A	1 of 1
enr/STERLING LIN/04/16/08 chr/STERLING LIN/04/16/08 oppd/MINERVA WANG/04/16/08				
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ACAD

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